



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Chuen Rong Leu et al.

Assignee:

**Bridge Semiconductor Corporation** 

Title:

METHOD OF MAKING A SEMICONDUCTOR CHIP ASSEMBLY WITH AN EMBEDDED METAL PILLAR

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COMMISSIONER FOR PATENTS

P.O. Box 1450

Alexandria, VA 22313

## TRANSMITTAL OF FORMAL DRAWINGS

Attached please find the formal drawings (36 sheets) for this application.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on January 18, 2006.

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Respectfully submitted,